



Board Manufacturing Specifications

Source Data From:

Project:

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HTLRBL32L-10_EvB-10

6.1

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Author:

Obs.:

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Specifications		Complementary Details
PCB Name:	HTLRBL32L-10 Evaluation Board	
Material:	Normal FR-4	
Size:	22,86 x 80mm	
Quantity:		
Layers:	2	
Sides with Components:	1	
TG (°C):		
Thickness (mm):	1.6	
Min Track/Spacing (mil):	6/6 (0.1524mm)	
Min Hole Size:	0.2mm	
Solder Mask:	Blue	
Solder Mask Height Control:		
Silkscreen:	White	
Surface Finish:	HASL lead free	
Via Type:	Tenting Vias	
Blind Vias:	No	
Buried Vias:	No	
Via Anular Size:	4mil (0.100mm)	
BGA:	No	
Finished Cooper:	1 oz. Cu	
Other Specifications / Observations:		